

# STARPOWER

SEMICONDUCTOR

IGBT

## GD75SGL120D6S

1200V/75A 1 in one-package

### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

### Features

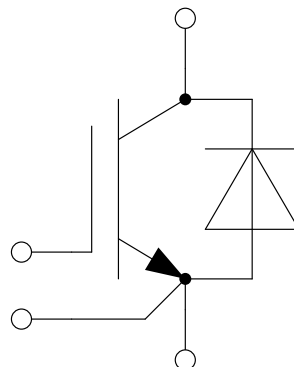
- Low  $V_{CE(sat)}$  SPT+ IGBT technology
- Low switching loss
- 10 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



### Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

### Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Collector Current @ $T_C=25^{\circ}\text{C}$	165	A
	@ $T_C=100^{\circ}\text{C}$	75	A
$I_{CM}$	Pulsed Collector Current $t_p=1\text{ms}$	150	A
$P_D$	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	684	W

**Diode**

Symbol	Description	Value	Unit
$V_{RRM}$	Repetitive Peak Reverse Voltage	1200	V
$I_F$	Diode Continuous Forward Current	75	A
$I_{FM}$	Diode Maximum Forward Current $t_p=1\text{ms}$	150	A

**Module**

Symbol	Description	Value	Unit
$T_{jmax}$	Maximum Junction Temperature	175	$^{\circ}\text{C}$
$T_{jop}$	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	4000	V

**IGBT Characteristics**  $T_c=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=75\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.90	2.35	V
		$I_C=75\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.10		
		$I_C=75\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		2.15		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=3.0\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.0	6.3	7.0	V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			5.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA
$R_{Gint}$	Internal Gate Resistance			3.0		$\Omega$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		5.52		nF
$C_{res}$	Reverse Transfer Capacitance			0.26		nF
$Q_G$	Gate Charge	$V_{GE}=-15 \dots +15\text{V}$		0.78		$\mu\text{C}$
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=75\text{A}, R_G=2.2\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		187		ns
$t_r$	Rise Time			41		ns
$t_{d(off)}$	Turn-Off Delay Time			244		ns
$t_f$	Fall Time			234		ns
$E_{on}$	Turn-On Switching Loss			3.41		mJ
$E_{off}$	Turn-Off Switching Loss			4.10		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=75\text{A}, R_G=2.2\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		189		ns
$t_r$	Rise Time			45		ns
$t_{d(off)}$	Turn-Off Delay Time			254		ns
$t_f$	Fall Time			375		ns
$E_{on}$	Turn-On Switching Loss			5.09		mJ
$E_{off}$	Turn-Off Switching Loss			6.40		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=75\text{A}, R_G=2.2\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$		196		ns
$t_r$	Rise Time			47		ns
$t_{d(off)}$	Turn-Off Delay Time			257		ns
$t_f$	Fall Time			407		ns
$E_{on}$	Turn-On Switching Loss			5.65		mJ
$E_{off}$	Turn-Off Switching Loss			7.00		mJ
$I_{SC}$	SC Data	$t_P \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=900\text{V}, V_{CEM} \leq 1200\text{V}$		350		A

**Diode Characteristics**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_F$	Diode Forward Voltage	$I_C=75\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		1.90	2.30	V
		$I_C=75\text{A}, V_{GE}=0\text{V}, T_j=125^{\circ}\text{C}$		1.90		
		$I_C=75\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.90		
$Q_r$	Recovered Charge	$V_R=600\text{V}, I_F=75\text{A},$ $-di/dt=2100\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^{\circ}\text{C}$		5.9		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			90		A
$E_{rec}$	Reverse Recovery Energy			3.06		mJ
$Q_r$	Recovered Charge	$V_R=600\text{V}, I_F=75\text{A},$ $-di/dt=2100\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^{\circ}\text{C}$		11.3		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			101		A
$E_{rec}$	Reverse Recovery Energy			5.50		mJ
$Q_r$	Recovered Charge	$V_R=600\text{V}, I_F=75\text{A},$ $-di/dt=2100\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^{\circ}\text{C}$		13.0		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			105		A
$E_{rec}$	Reverse Recovery Energy			6.60		mJ

**Module Characteristics**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
$R_{thJC}$	Junction-to-Case (per IGBT)			0.219	K/W
	Junction-to-Case (per Diode)			0.430	
$R_{thCH}$	Case-to-Heatsink (per IGBT)		0.226		K/W
	Case-to-Heatsink (per Diode)		0.445		
	Case-to-Heatsink (per Module)		0.150		
M	Terminal Connection Torque, Screw M3	2.5		5.0	N.m
	Mounting Torque, Screw M3	2.5		5.0	
G	Weight of Module		35		g

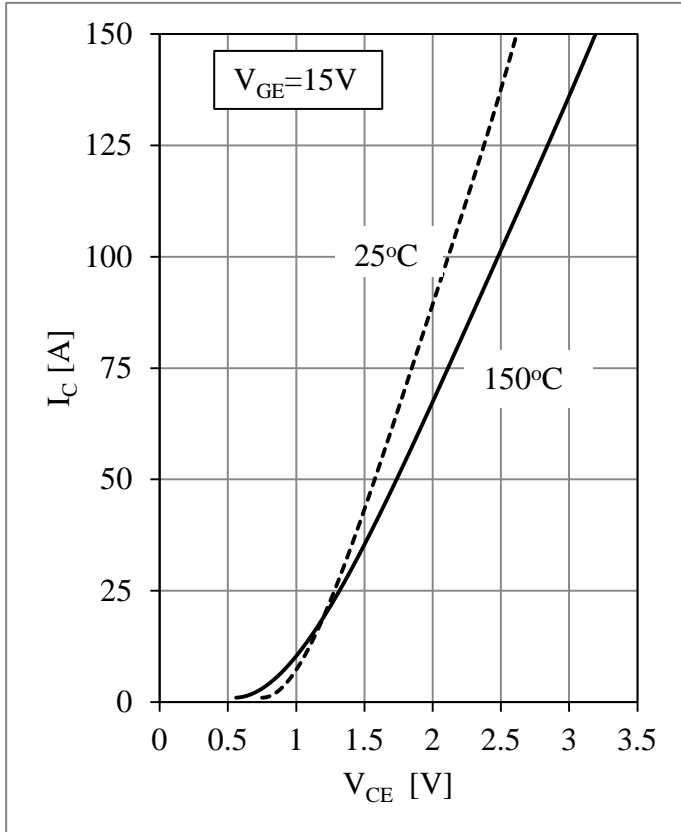


Fig 1. IGBT Output Characteristics

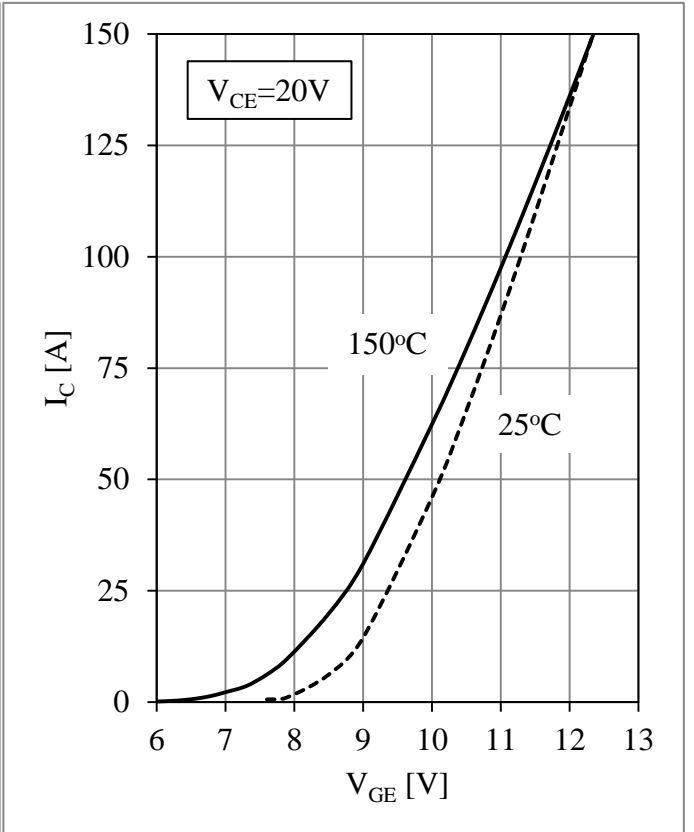


Fig 2. IGBT Transfer Characteristics

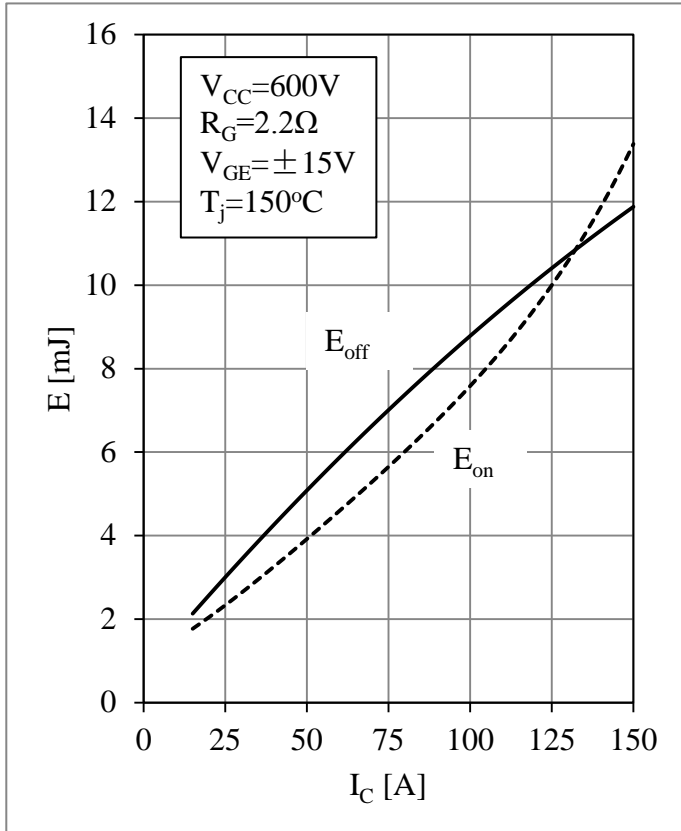


Fig 3. IGBT Switching Loss vs.  $I_C$

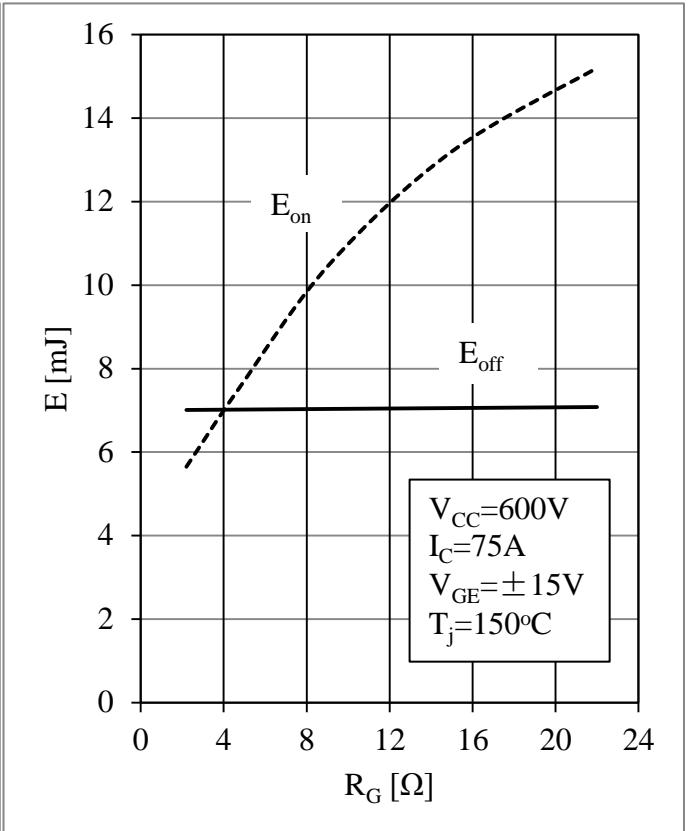


Fig 4. IGBT Switching Loss vs.  $R_G$

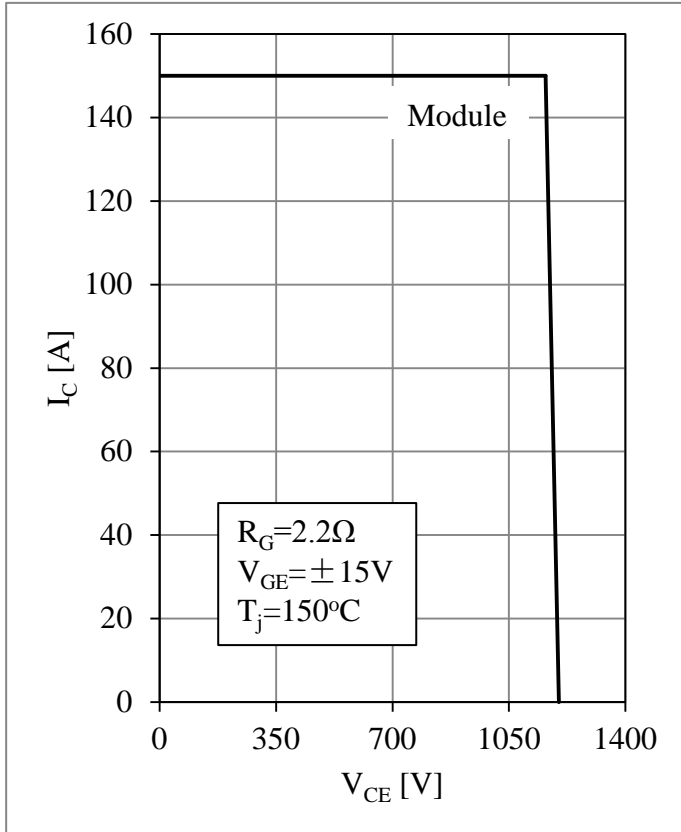


Fig 5. RBSOA

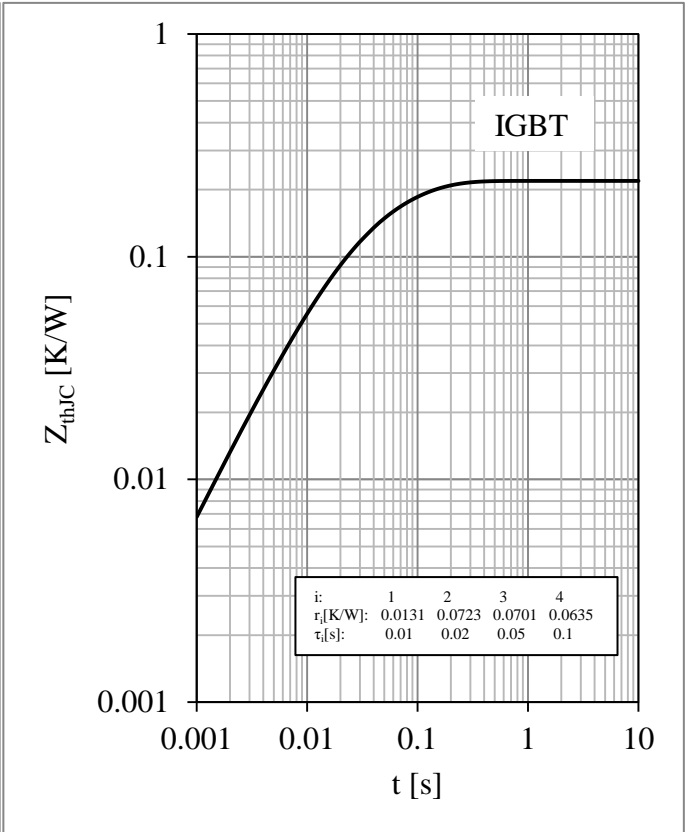


Fig 6. IGBT Transient Thermal Impedance

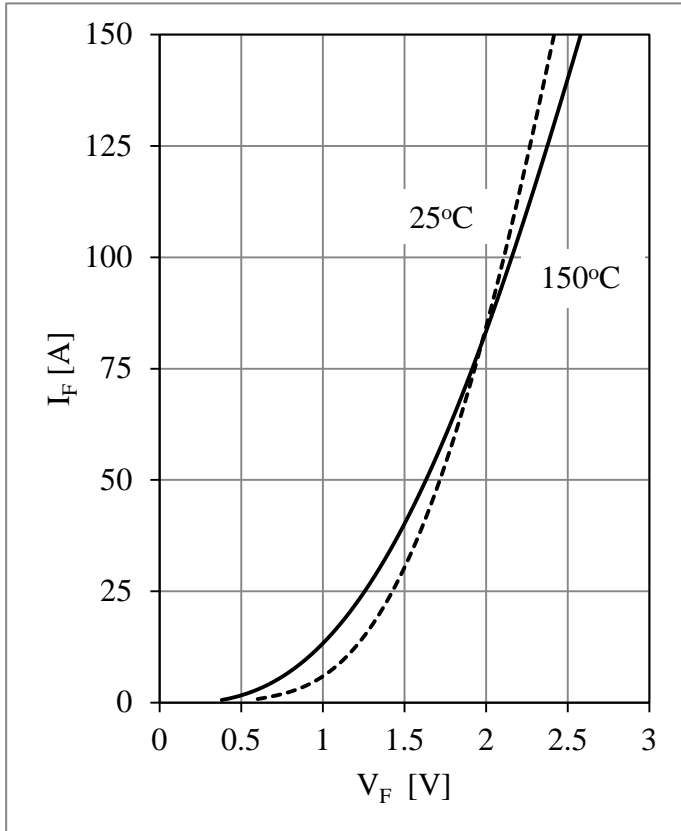


Fig 7. Diode Forward Characteristics

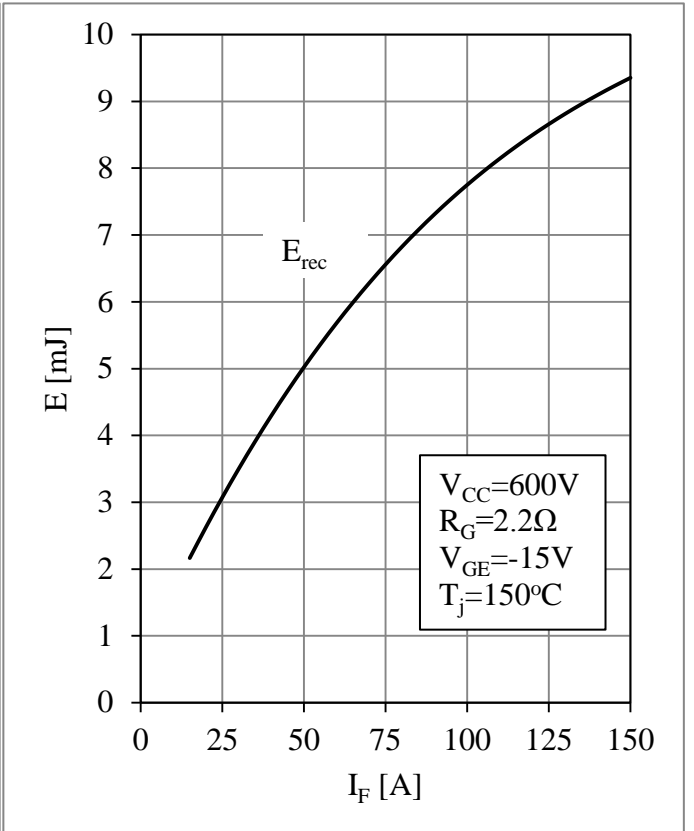


Fig 8. Diode Switching Loss vs.  $I_F$

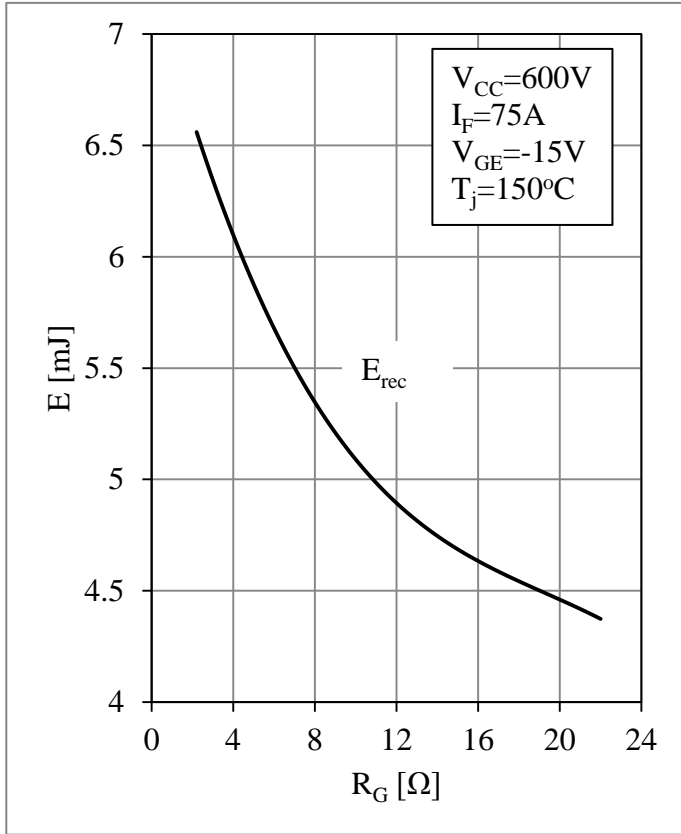


Fig 9. Diode Switching Loss vs.  $R_G$

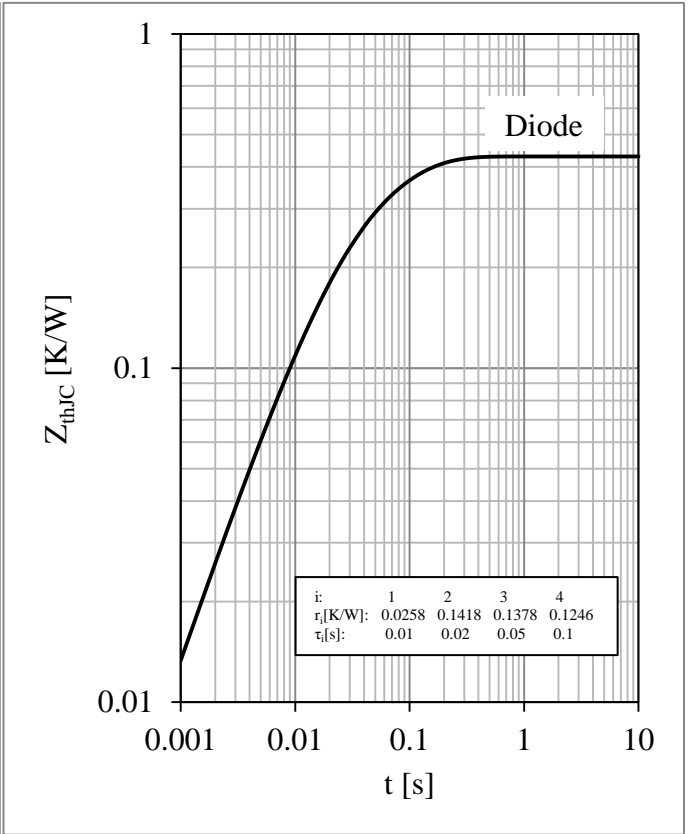
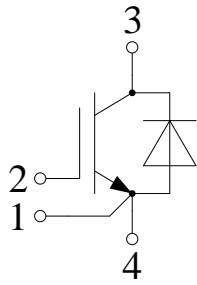
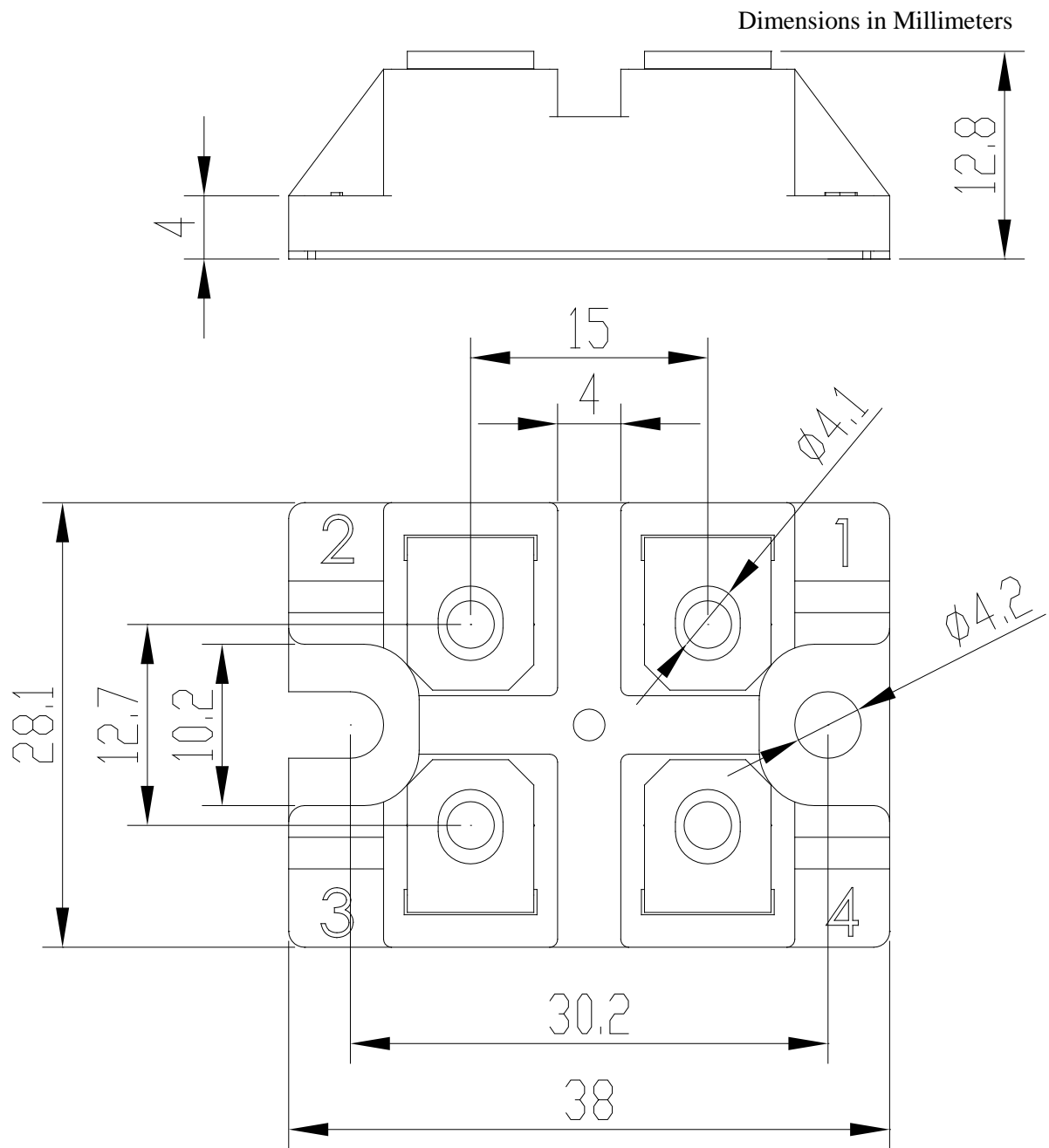


Fig 10. Diode Transient Thermal Impedance

**Circuit Schematic**



**Package Dimensions**





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